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Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

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BLL8H1214L-250; BLL8H1214LS-250

LDMOS L-band radar power transistor

Rev. 3 — 1 September 2015

AMPLEON

Product data sheet

1. Product profile

1.1 General description

250 W LDMOS power transistor intended for L-band radar applications in the 1.2 GHz to 1.4 GHz range.

Table 1. Test information

Typical RF performance at $T_{case} = 25\text{ °C}$; $t_p = 300\text{ }\mu\text{s}$; $\delta = 10\%$; $I_{Dq} = 100\text{ mA}$; in a class-AB production test circuit.

Test signal	f	V _{DS}	P _L	G _p	η_D	t _r	t _f
	(GHz)	(V)	(W)	(dB)	(%)	(ns)	(ns)
pulsed RF	1.2 to 1.4	50	250	17	55	15	5

1.2 Features and benefits

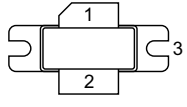
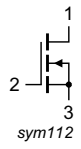
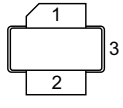
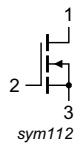
- Easy power control
- Integrated dual side ESD protection
- High flexibility with respect to pulse formats
- Excellent ruggedness
- High efficiency
- Excellent thermal stability
- Designed for broadband operation (1.2 GHz to 1.4 GHz)
- Internally matched for ease of use
- Compliant to Directive 2002/95/EC, regarding restriction of hazardous substances (RoHS)

1.3 Applications

- L-band power amplifiers for radar applications in the 1.2 GHz to 1.4 GHz frequency range

2. Pinning information

Table 2. Pinning

Pin	Description	Simplified outline	Graphic symbol
BLL8H1214L-250 (SOT502A)			
1	drain		 sym112
2	gate		
3	source ^[1]		
BLL8H1214LS-250 (SOT502B)			
1	drain		 sym112
2	gate		
3	source ^[1]		

[1] Connected to flange.

3. Ordering information

Table 3. Ordering information

Type number	Package		Version
	Name	Description	
BLL8H1214L-250	-	flanged ceramic package; 2 mounting holes; 2 leads	SOT502A
BLL8H1214LS-250	-	earless flanged ceramic package; 2 leads	SOT502B

4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DS}	drain-source voltage		-	100	V
V_{GS}	gate-source voltage		-6	+13	V
T_{stg}	storage temperature		-65	+150	°C
T_j	junction temperature	^[1]	-	225	°C

[1] Continuous use at maximum temperature will affect the reliability, for details refer to the on-line MTF calculator.

5. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Typ	Unit
$Z_{th(j-c)}$	transient thermal impedance from junction to case	$T_{case} = 85\text{ °C}; P_L = 250\text{ W}$		
		$t_p = 100\text{ }\mu\text{s}; \delta = 10\text{ %}$	0.10	K/W
		$t_p = 200\text{ }\mu\text{s}; \delta = 10\text{ %}$	0.13	K/W
		$t_p = 300\text{ }\mu\text{s}; \delta = 10\text{ %}$	0.15	K/W
		$t_p = 100\text{ }\mu\text{s}; \delta = 20\text{ %}$	0.14	K/W
		$t_p = 500\text{ }\mu\text{s}; \delta = 20\text{ %}$	0.20	K/W

6. Characteristics

Table 6. DC characteristics

$T_j = 25\text{ °C}$.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_{(BR)DSS}$	drain-source breakdown voltage	$V_{GS} = 0\text{ V}; I_D = 2.7\text{ mA}$	100	-	-	V
$V_{GS(th)}$	gate-source threshold voltage	$V_{DS} = 10\text{ V}; I_D = 270\text{ mA}$	1.3	1.8	2.25	V
I_{DSS}	drain leakage current	$V_{GS} = 0\text{ V}; V_{DS} = 50\text{ V}$	-	-	1.4	μA
I_{DSX}	drain cut-off current	$V_{GS} = V_{GS(th)} + 3.75\text{ V}; V_{DS} = 10\text{ V}$	32	42	-	A
I_{GSS}	gate leakage current	$V_{GS} = 11\text{ V}; V_{DS} = 0\text{ V}$	-	-	140	nA
g_{fs}	forward transconductance	$V_{DS} = 10\text{ V}; I_D = 270\text{ mA}$	1.6	2.3	-	S
$R_{DS(on)}$	drain-source on-state resistance	$V_{GS} = V_{GS(th)} + 3.75\text{ V}; I_D = 9.5\text{ A}$	-	100	169	m Ω

Table 7. RF characteristics

Test signal: pulsed RF; $t_p = 300\text{ }\mu\text{s}; \delta = 10\text{ %}$; RF performance at $V_{DS} = 50\text{ V}; I_{Dq} = 100\text{ mA}$; $T_{case} = 25\text{ °C}$; unless otherwise specified, in a class-AB production test circuit.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{DS}	drain-source voltage	$P_L = 250\text{ W}$	-	-	50	V
G_p	power gain	$P_L = 250\text{ W}$	15	17	-	dB
RL_{in}	input return loss	$P_L = 250\text{ W}$	-	-10	-	dB
$P_{L(1dB)}$	output power at 1 dB gain compression		-	300	-	W
η_D	drain efficiency	$P_L = 250\text{ W}$	49	55	-	%
$P_{droop(pulse)}$	pulse droop power	$P_L = 250\text{ W}$	-	0	0.3	dB
t_r	rise time	$P_L = 250\text{ W}$	-	15	-	ns
t_f	fall time	$P_L = 250\text{ W}$	-	5	-	ns

7. Application information

7.1 Ruggedness in class-AB operation

The BLL8H1214L-250 and BLL8H1214LS-250 are capable of withstanding a load mismatch corresponding to VSWR = 10 : 1 through all phases under the following conditions: $V_{DS} = 50\text{ V}$; $I_{DQ} = 100\text{ mA}$; $P_L = 250\text{ W}$; $t_p = 300\text{ }\mu\text{s}$; $\delta = 10\text{ }\%$.

7.2 Impedance information

Table 8. Typical impedance
Typical values unless otherwise specified.

f (GHz)	Z_S (Ω)	Z_L (Ω)
1.2	1.268 – j2.623	2.987 – j1.664
1.3	2.193 – j2.457	2.162 – j1.326
1.4	2.359 – j2.052	1.604 – j1.887

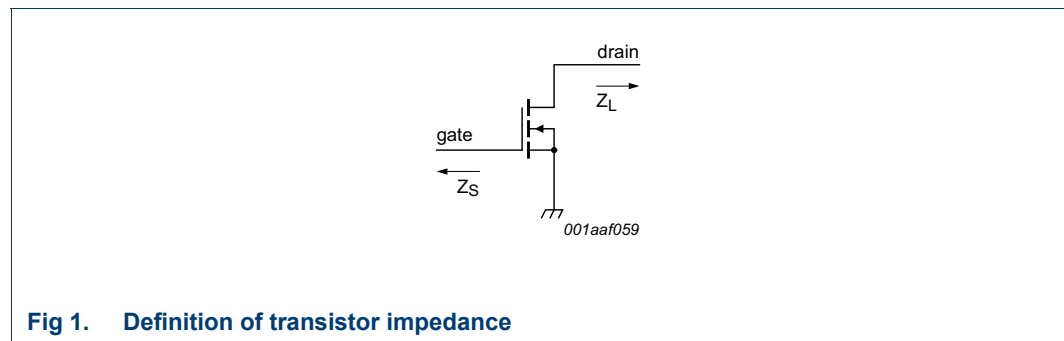


Fig 1. Definition of transistor impedance

7.3 Application circuit

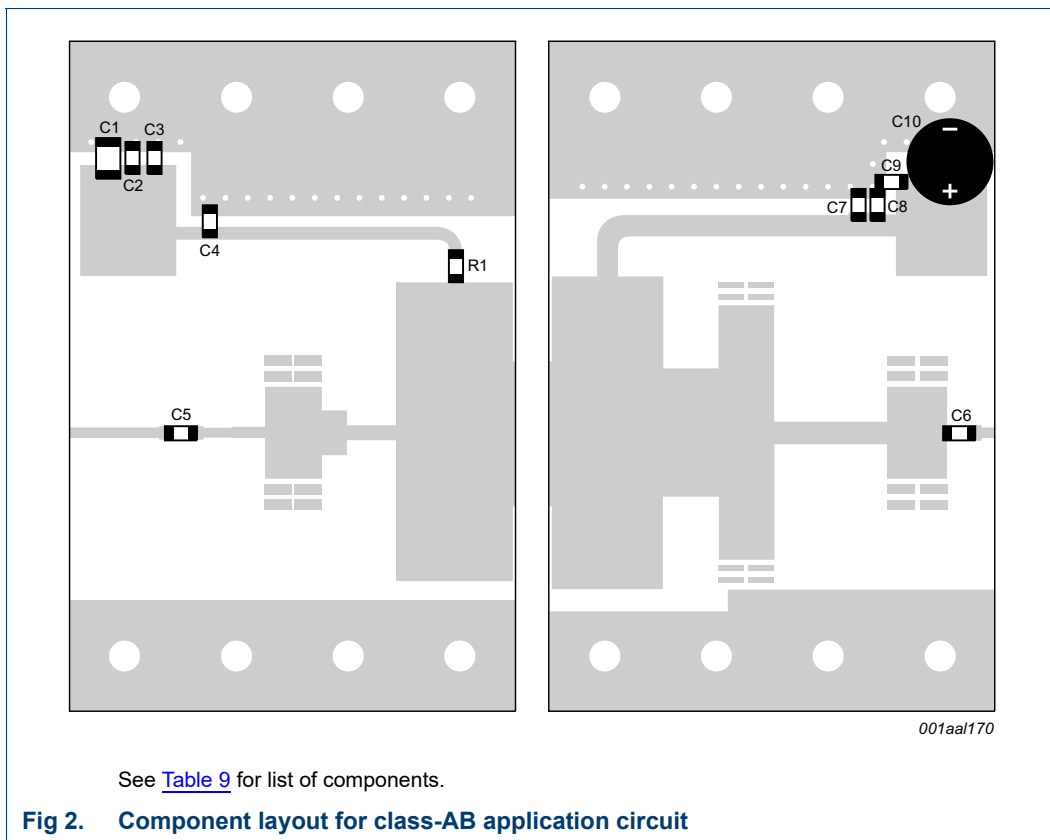


Table 9. List of components

See [Figure 2](#).

Striplines are on a Rogers Duroid 6006 Printed-Circuit Board (PCB); $\epsilon_r = 6.15$ F/m; thickness = 0.64 mm

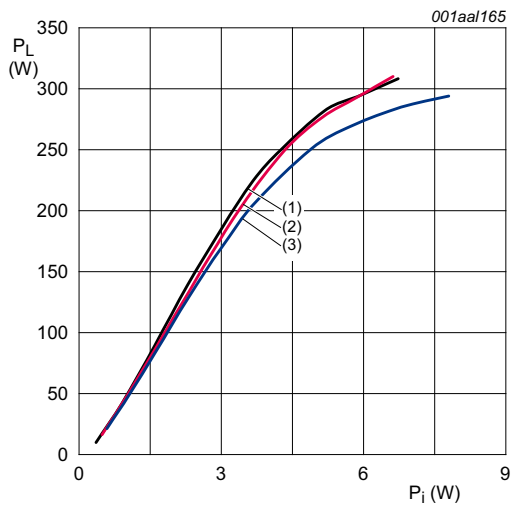
Component	Description	Value	Remarks
C1	multilayer ceramic chip capacitor	10 μ F, 35 V [1]	
C2, C4	multilayer ceramic chip capacitor	51 pF [2]	
C3, C8	multilayer ceramic chip capacitor	1 nF [2]	
C5	multilayer ceramic chip capacitor	82 pF [3]	
C6, C7	multilayer ceramic chip capacitor	56 pF [3]	
C9	multilayer ceramic chip capacitor	100 pF [3]	
C10	electrolytic capacitor	47 μ F, 63 V	
R1	SMD resistor	10 Ω	SMD 0603

[1] American Technical Ceramics type 100A or capacitor of same quality.

[2] American Technical Ceramics type 100B or capacitor of same quality.

[3] American Technical Ceramics type 800B or capacitor of same quality.

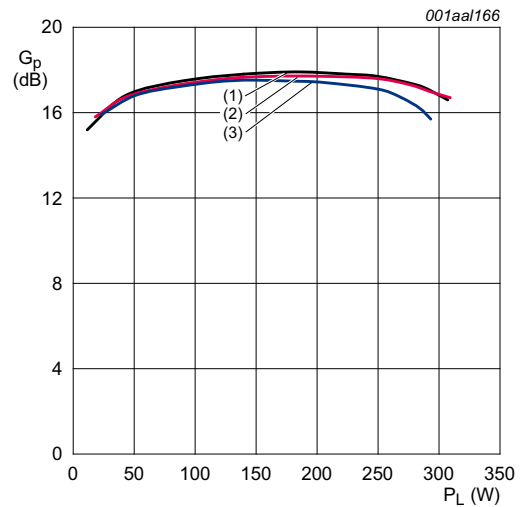
7.4 RF performance graphs



$V_{DS} = 50 \text{ V}$; $t_p = 300 \text{ } \mu\text{s}$; $\delta = 10 \%$; $I_{Dq} = 100 \text{ mA}$.

- (1) $f = 1200 \text{ MHz}$
- (2) $f = 1300 \text{ MHz}$
- (3) $f = 1400 \text{ MHz}$

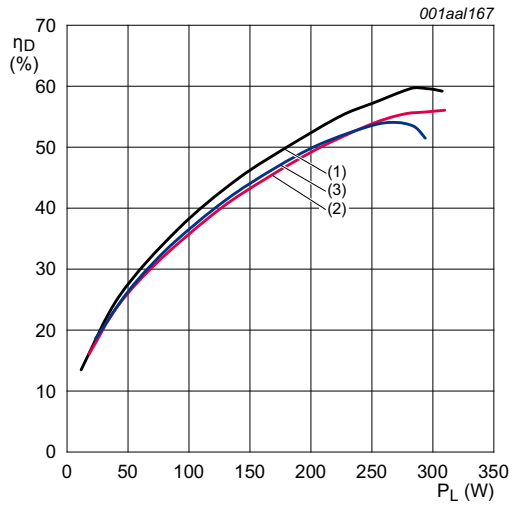
Fig 3. Output power as a function of input power; typical values



$V_{DS} = 50 \text{ V}$; $t_p = 300 \text{ } \mu\text{s}$; $\delta = 10 \%$; $I_{Dq} = 100 \text{ mA}$.

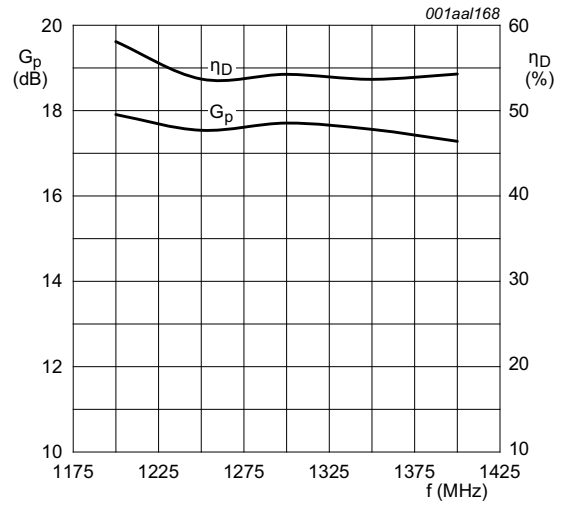
- (1) $f = 1200 \text{ MHz}$
- (2) $f = 1300 \text{ MHz}$
- (3) $f = 1400 \text{ MHz}$

Fig 4. Power gain as a function of output power; typical values



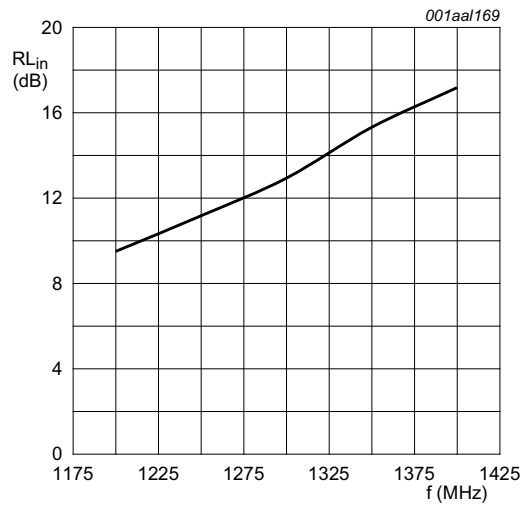
$V_{DS} = 50 \text{ V}$; $t_p = 300 \text{ }\mu\text{s}$; $\delta = 10 \text{ }\%$; $I_{Dq} = 100 \text{ mA}$.
 (1) $f = 1200 \text{ MHz}$
 (2) $f = 1300 \text{ MHz}$
 (3) $f = 1400 \text{ MHz}$

Fig 5. Drain efficiency as a function of output power; typical values



$P_L = 250 \text{ W}$; $V_{DS} = 50 \text{ V}$; $t_p = 300 \text{ }\mu\text{s}$; $\delta = 10 \text{ }\%$; $I_{Dq} = 100 \text{ mA}$.

Fig 6. Power gain and drain efficiency as function of frequency; typical values



$P_L = 250 \text{ W}$; $V_{DS} = 50 \text{ V}$; $t_p = 300 \text{ }\mu\text{s}$; $\delta = 10 \text{ }\%$; $I_{Dq} = 100 \text{ mA}$.

Fig 7. Input return loss as a function of frequency; typical value

8. Package outline

Flanged ceramic package; 2 mounting holes; 2 leads

SOT502A

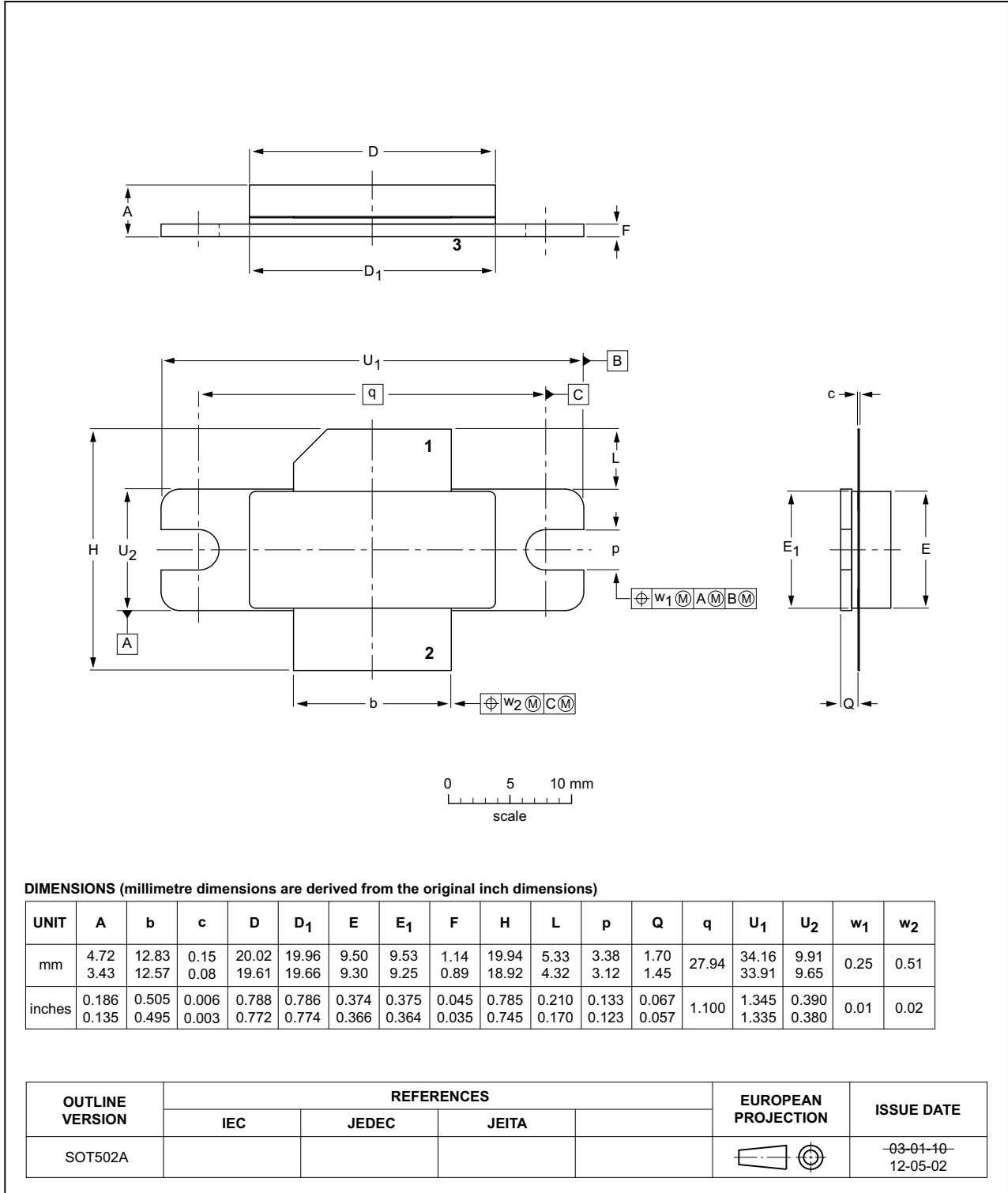


Fig 8. Package outline SOT502A

Earless flanged ceramic package; 2 leads

SOT502B

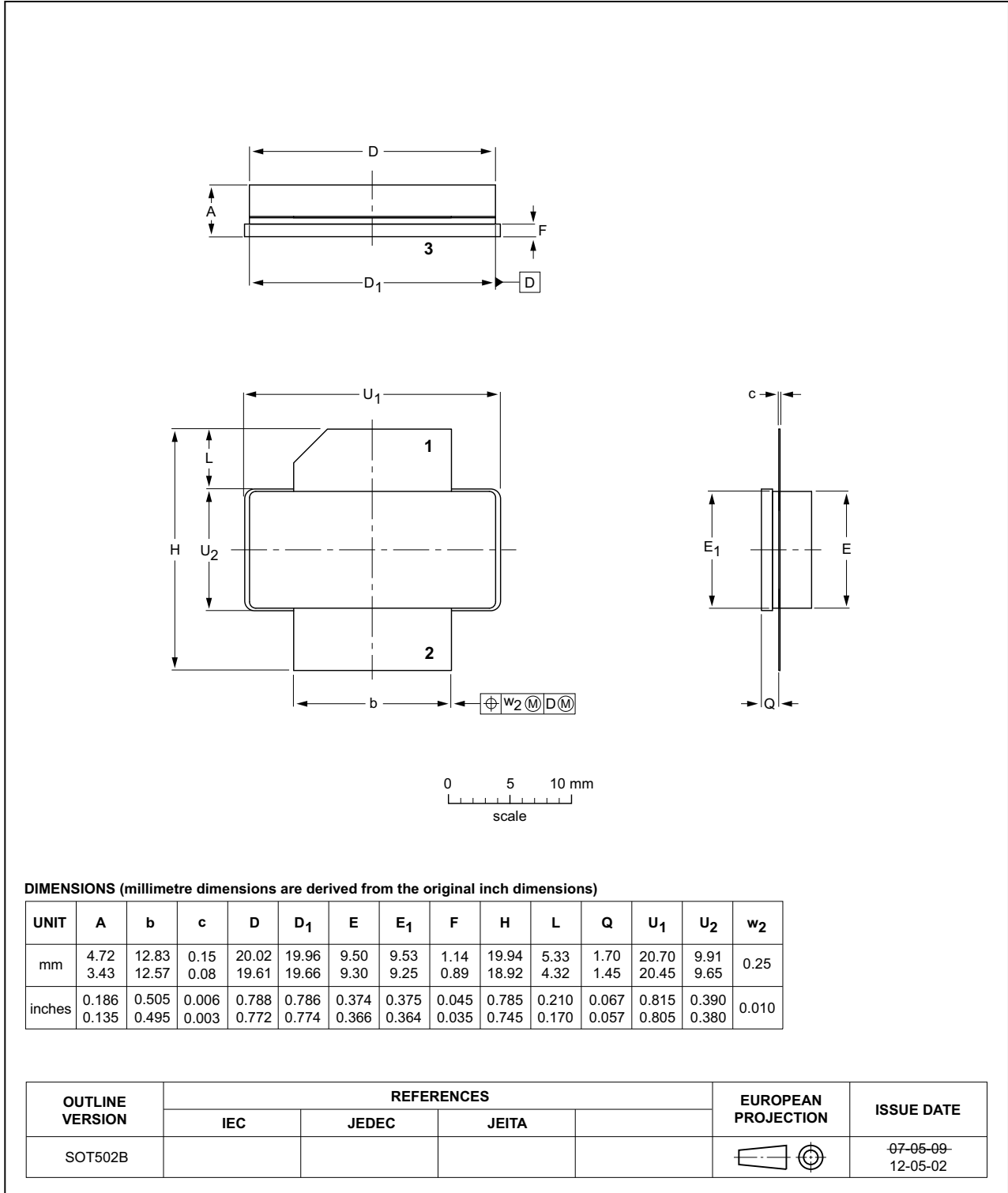



Fig 9. Package outline SOT502B

9. Handling information

CAUTION	
	<p>This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.</p> <p>Such precautions are described in the <i>ANSI/ESD S20.20</i>, <i>IEC/ST 61340-5</i>, <i>JESD625-A</i> or equivalent standards.</p>

10. Abbreviations

Table 10. Abbreviations

Acronym	Description
ESD	ElectroStatic Discharge
L-band	Long wave Band
LDMOS	Laterally Diffused Metal-Oxide Semiconductor
MTF	Median Time to Failure
SMD	Surface Mounted Device
VSWR	Voltage Standing-Wave Ratio

11. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BLL8H1214L-250_1214LS-250#3	20150901	Product data sheet	-	BLL8H1214L-250_1214LS-250 #2
Modifications:	<ul style="list-style-type: none"> The format of this document has been redesigned to comply with the new identity guidelines of Ampleon. Legal texts have been adapted to the new company name where appropriate. 			
BLL8H1214L-250_1214LS-250 #2	20150113	Product data sheet	-	BLL8H1214L-250_1214LS-250 #1
BLL8H1214L-250_1214LS-250 #1	20140930	Objective data sheet	-	-

12. Legal information

12.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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[2] The term 'short data sheet' is explained in section "Definitions".

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